



# ***Sandia National Laboratories' Programs***

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- 1. Electroactive Ionic Liquids:  
*A New Approach to Flow Batteries***
- 2. Gallium Nitride Substrates for Power Electronics:  
*Electrochemical Solution Growth***

**Karen Waldrip, PhD**

**Advanced Power Sources R&D**

**Sandia National Labs, Albuquerque, NM**

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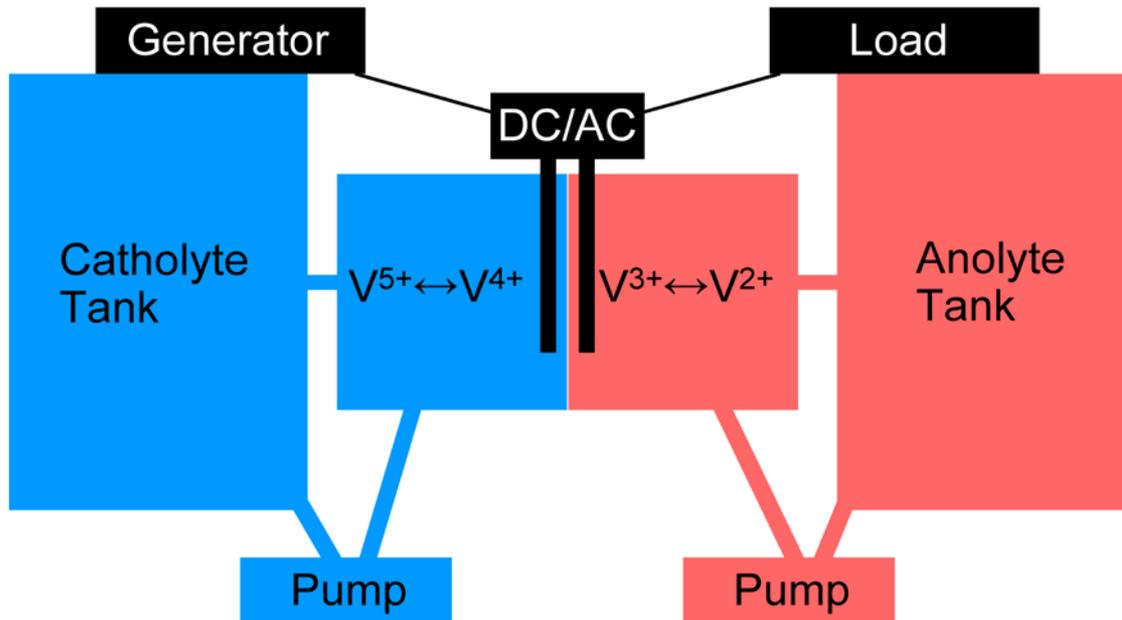
# **Electroactive Ionic Liquids: A New Approach To Flow Batteries**

**Date**

**Travis Anderson  
David Ingersoll  
Chad Staiger  
Karen Waldrip**

# Flow Batteries

## Vanadium Redox Battery (VRB)



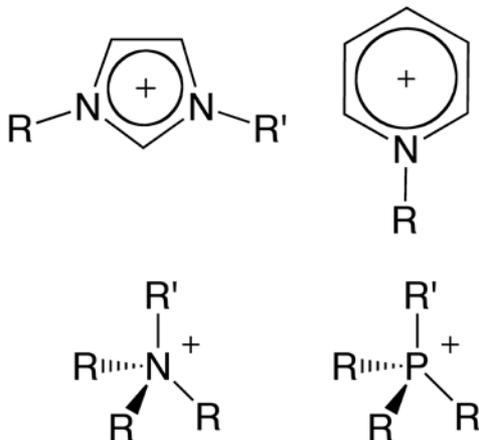
- No cross contamination
- Flexible layout
- High cycle life
- Large, tunable capacity
- Low maintenance

vanadium redox couples are in both cells, separated by a proton exchange membrane

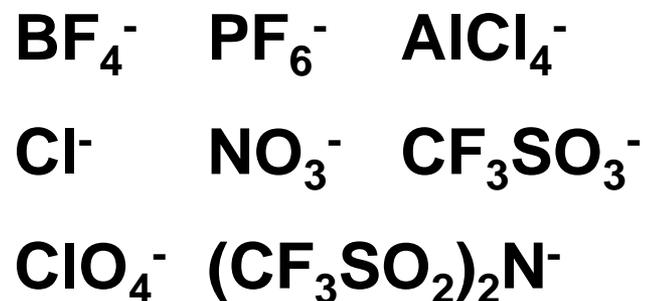


# Ionic Liquids

## Common Cations



## Common Anions

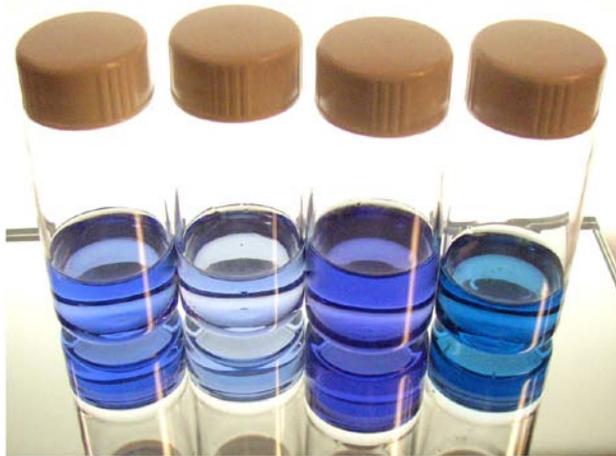


## Synthetic “Targets”

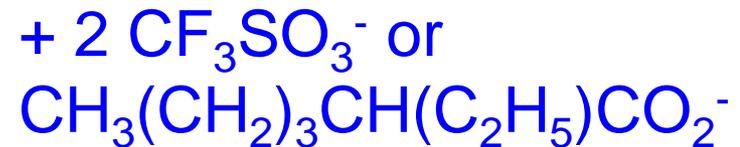
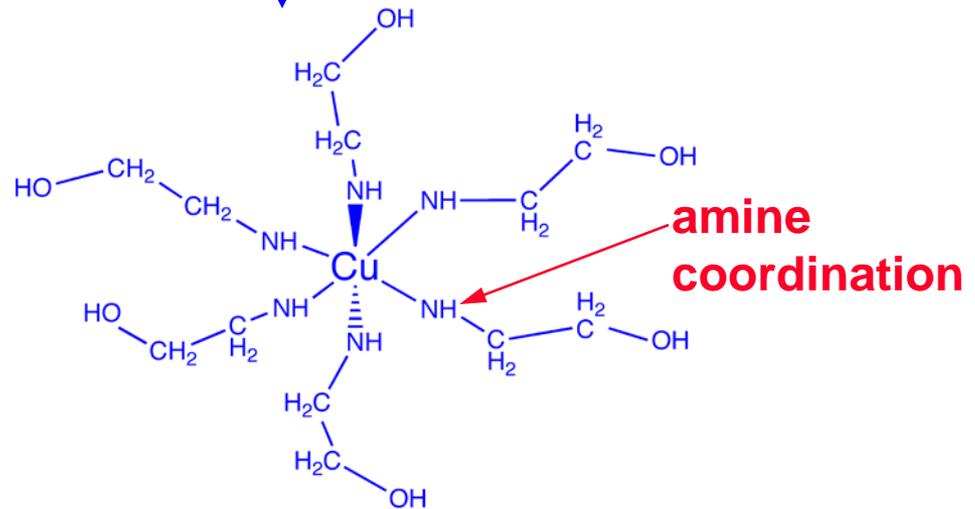
- Low symmetry
- Weak Intermolecular Interactions
- Low charge density



# Synthesis of Electroactive Ionic Liquids



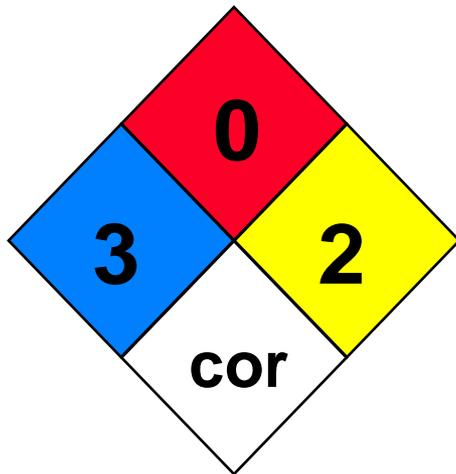
$\Delta 75^\circ\text{C}, 45 \text{ min}$



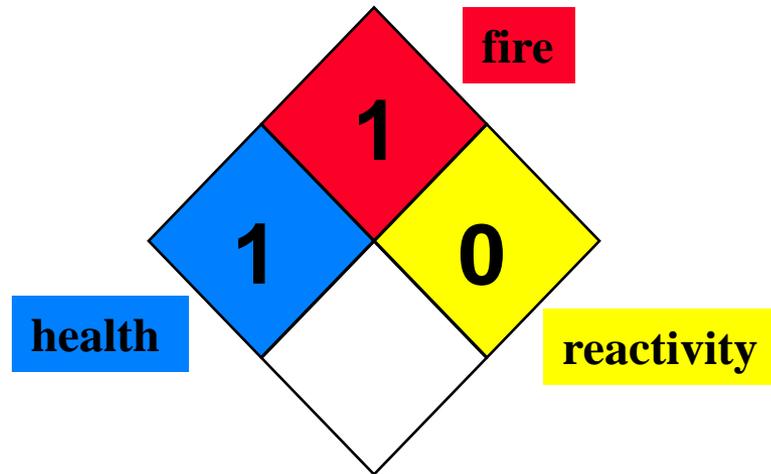
- scalable
- versatile
- low cost
- two functional groups



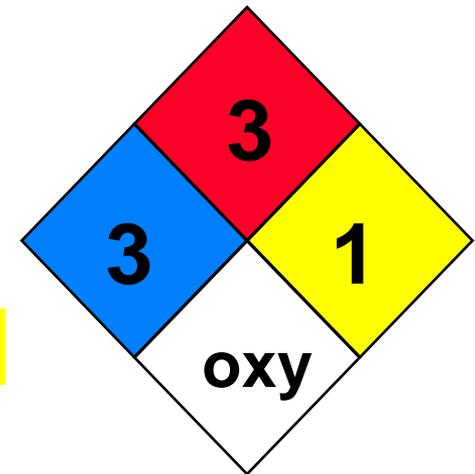
# Flow Battery Safety



Vanadium Redox  
Battery



Sandia Ionic Liquid



Zinc Bromine Flow  
Battery

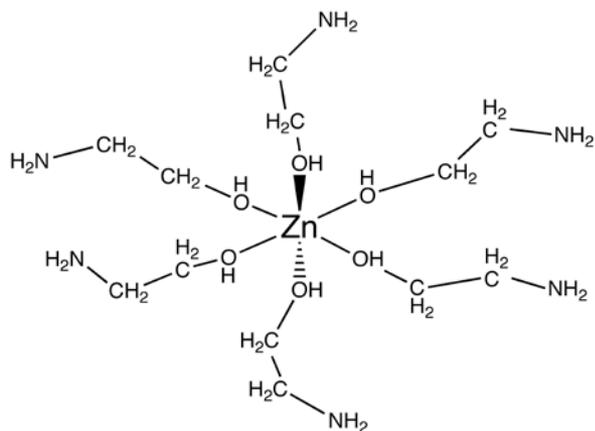
Ionic liquids have no vapor pressure, thus mitigating cell pressurization issues

Data based on individual components

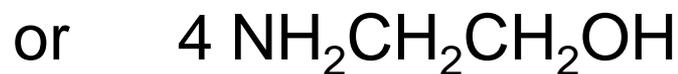
# Versatile Synthesis



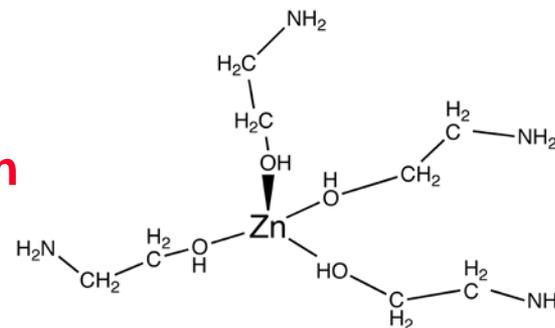
$\Delta$  75 °C, 30 min



**alcohol  
coordination**



$\Delta$  115 °C, 30 min



The coordination geometry can be varied by changing the reaction stoichiometry.

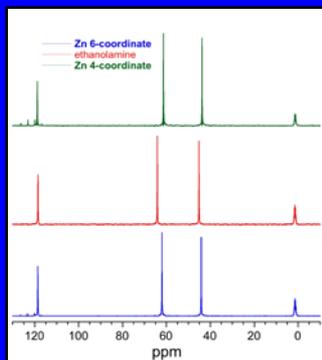


# Seven New Electroactive Ionic Liquids

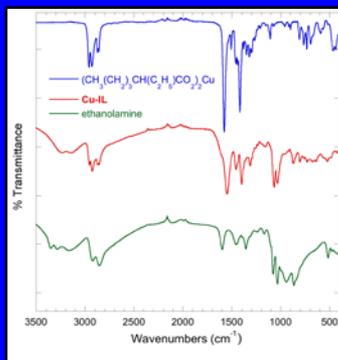
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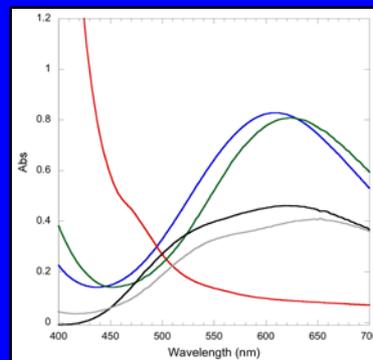
# Spectroscopic Studies of Synthesized Ionic Liquids



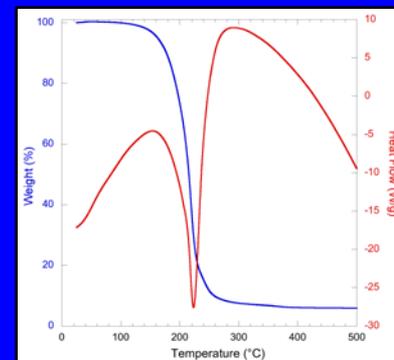
**<sup>13</sup>C NMR Spectroscopy**



**Infrared Spectroscopy**

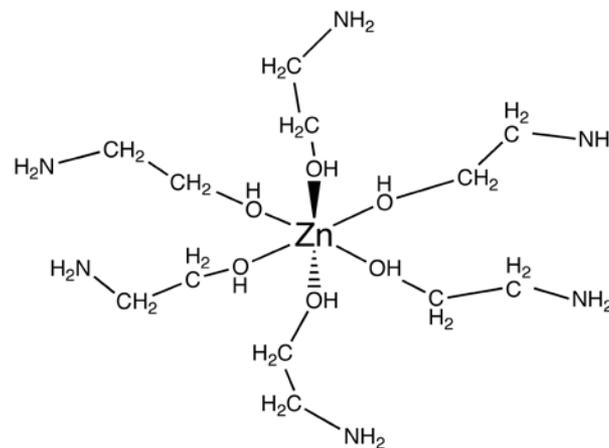


**Electronic Absorption**



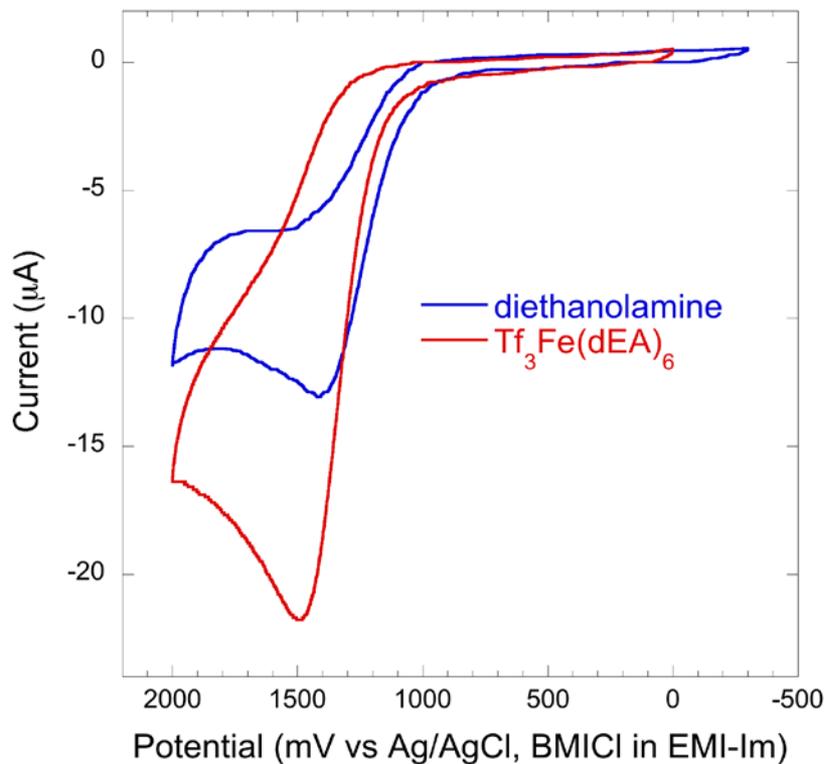
**Thermal Stability**

- Determine molecular structures
- Relate structure to properties
- Tailor synthesis procedure to obtain molecules with desired properties (e.g., d.p. 150-255C)

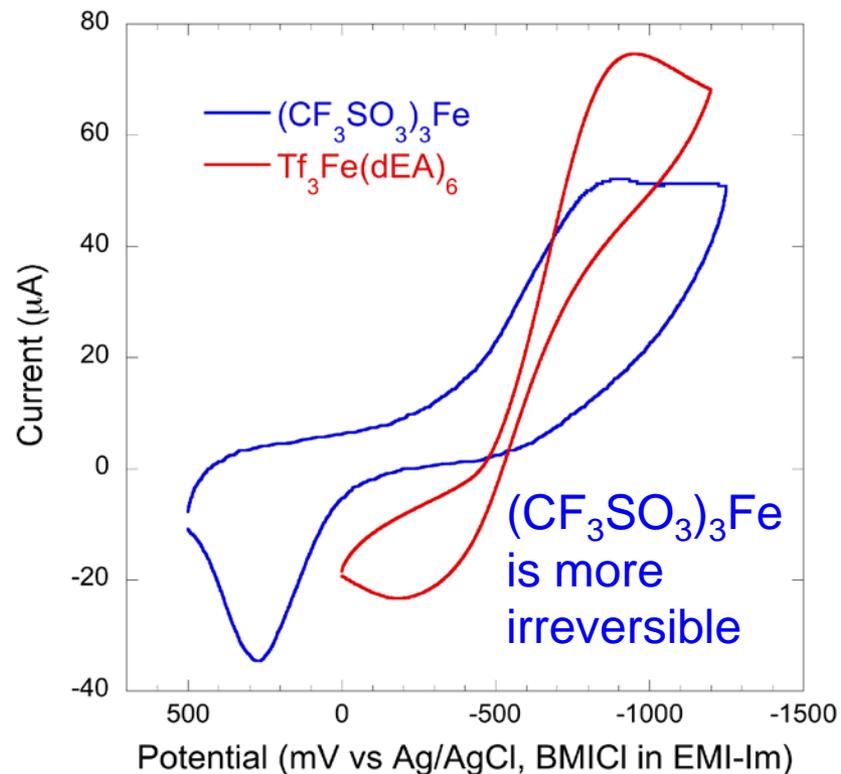


# Cyclic Voltammetry

## Ligand Oxidation



## Metal Redox



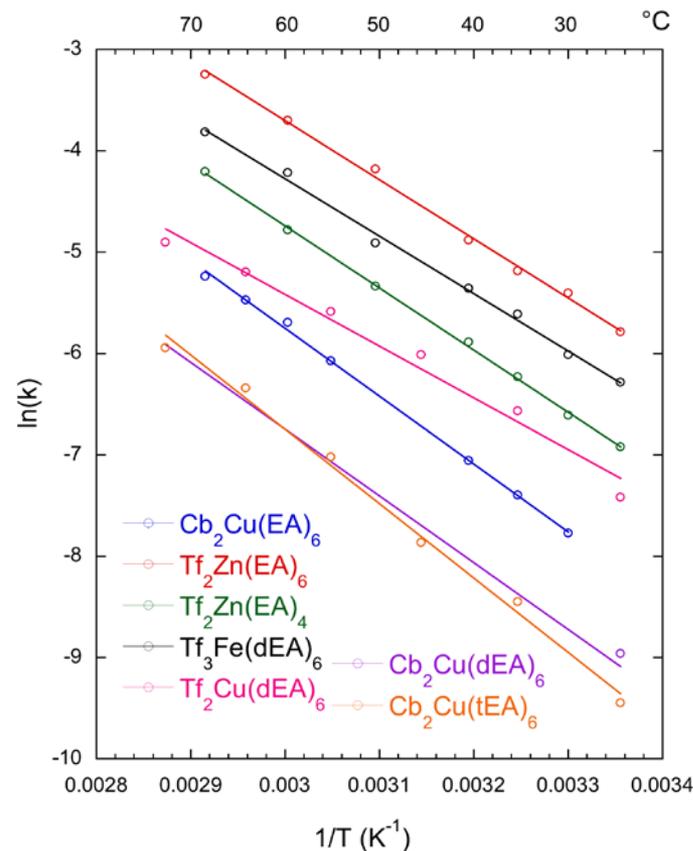
Conditions: Pt working electrode, 1 M  $\text{TEABF}_4$  in  $\text{CH}_3\text{CN}$

# Conductivity Studies

Complex	Specific Conductivity ( $\mu\text{S cm}^{-1}$ ) at 25 °C	Activation Energy ( $\text{kcal mol}^{-1}$ )
$\text{Cb}_2\text{Cu}(\text{tEA})_6$	8.77	13.3
$\text{Cb}_2\text{Cu}(\text{dEA})_6$	14.3	11.6
$\text{Cb}_2\text{Cu}(\text{EA})_6$	44.6	12.2
$\text{Tf}_2\text{Cu}(\text{dEA})_6$	66.7	11.2
$\text{Tf}_2\text{Zn}(\text{EA})_4$	101	8.9
$\text{Tf}_3\text{Fe}(\text{dEA})_6$	207	13.1
$\text{Tf}_2\text{Zn}(\text{EA})_6$	341	14.6

the specific conductivity of common battery electrolytes at 25 °C is  $\sim 0.5\text{-}1 \text{ S cm}^{-1}$

$E_a$  of aqueous (and molten) metal salt  $\sim 3\text{-}5 \text{ kcal mol}^{-1}$



conductivity is low: suggests significant ion pairing



# Path Forward

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## Anion Exchange to Increase Conductivity

- ORNL compounds  $M(\text{NH}_3\text{-R})_2(\text{CF}_3\text{SO}_2)_2\text{N}$  increased conductivity by three orders of magnitude

## Decrease Viscosity to Increase Efficiency

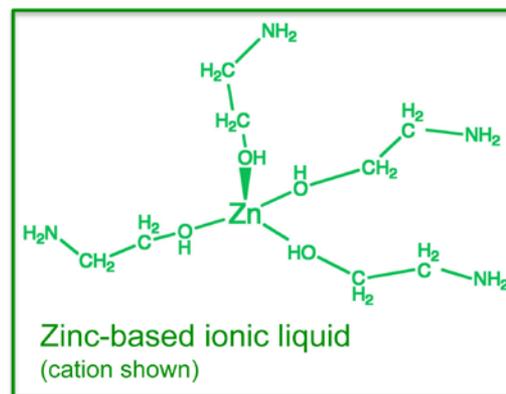
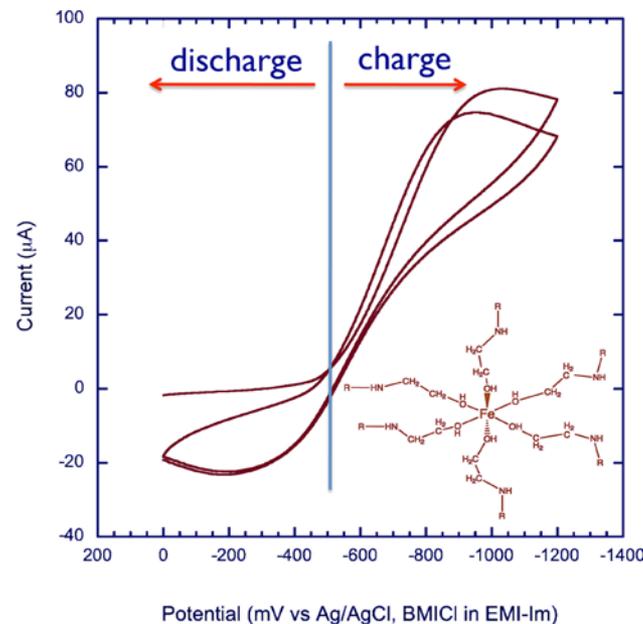
- The increased hydrophobicity of  $(\text{CF}_3\text{SO}_2)_2\text{N}$  will decrease the internal resistance to power extraction

## Increase Molar Concentration of Metals

- Increases energy density
- Metal-Ligand exchange, mixed metal systems

# Conclusions and Future Work

- Although we have demonstrated the compounds may serve as a **liquid electrode** they are not yet appropriate as the **electrolyte**
- Future work on the electroactive ionic liquids will focus on both new **ligands** and new **anions** to increase hydrophobicity
- Evaluate the effect of hydrophobicity on the fundamental electrochemical characteristics





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# **Electrochemical Solution Growth (ESG) of Gallium Nitride for Power Electronics**

**Karen Waldrip**

**Sandia National Labs, Albuquerque, NM**

**Dave F. Smith**

**GNOEM Systems, Boulder Creek, CA**

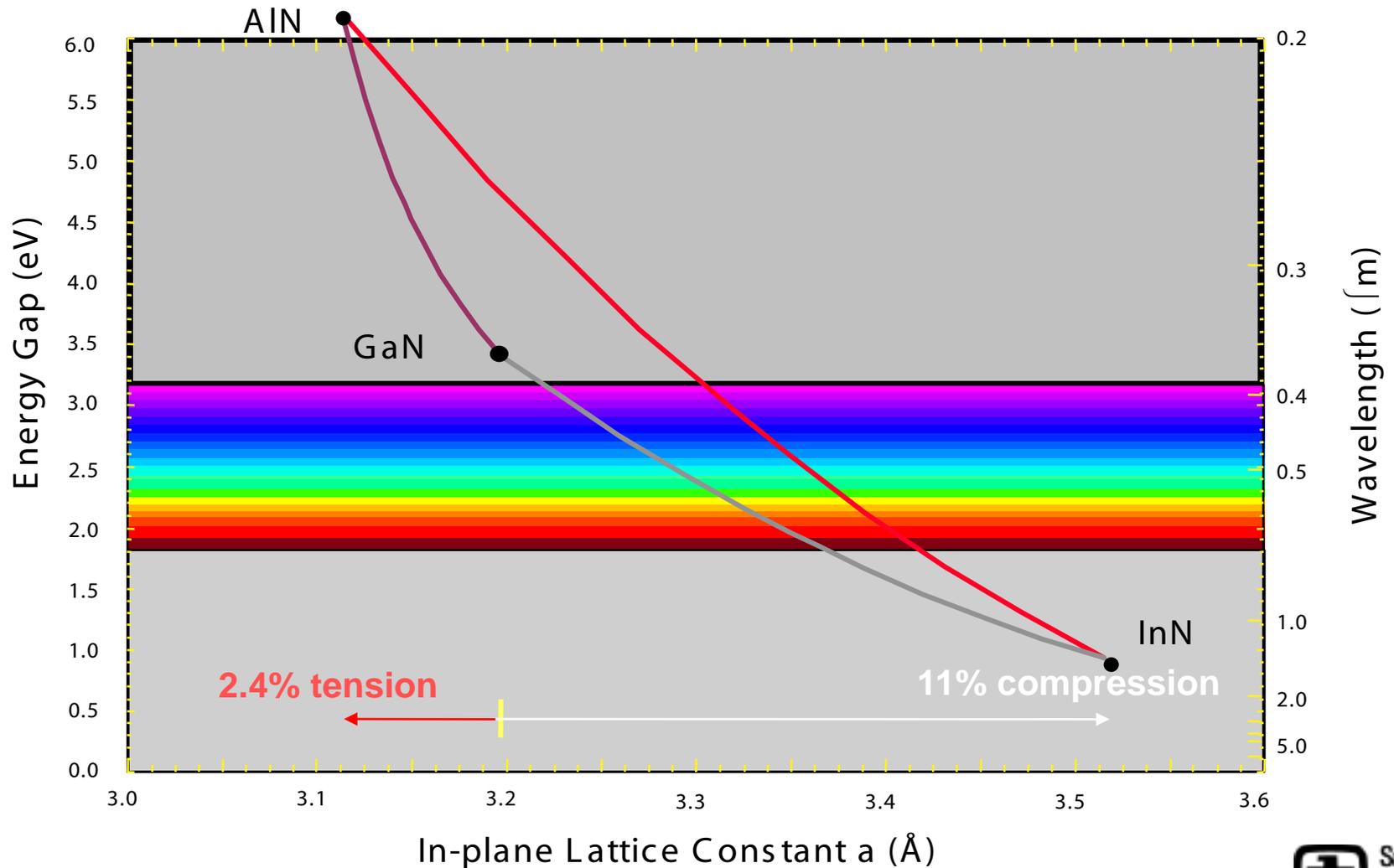


## Combined Figure of Merit

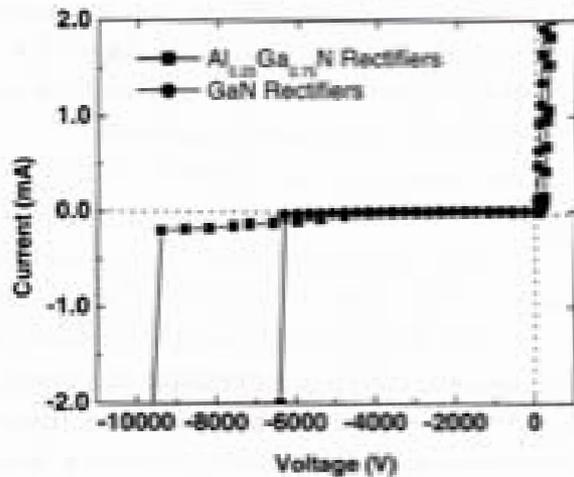
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	K (W/cm°C)	$E_c$ (MV/cm)	$\epsilon$	$\mu$ (cm <sup>2</sup> /Vs)	$v_s$	Combined Figure of Merit
Si	1.31	0.3	11.8	1350	$1 \times 10^7$	1
SiC	4.9	2	10	650	$2 \times 10^7$	136
GaN	1.3	3.3	9	1200	$2.5 \times 10^7$	153

# Energy gap - lattice parameter diagram of III-nitrides



# Heterostructure Rectifiers Offer Improved Breakdown Voltages



- 9.7 kV for Al<sub>0.25</sub>Ga<sub>0.75</sub>N
- Leakage current due to bulk defects

# GaN is Grown Heteroepitaxially on Sapphire (and Silicon Carbide) Substrates

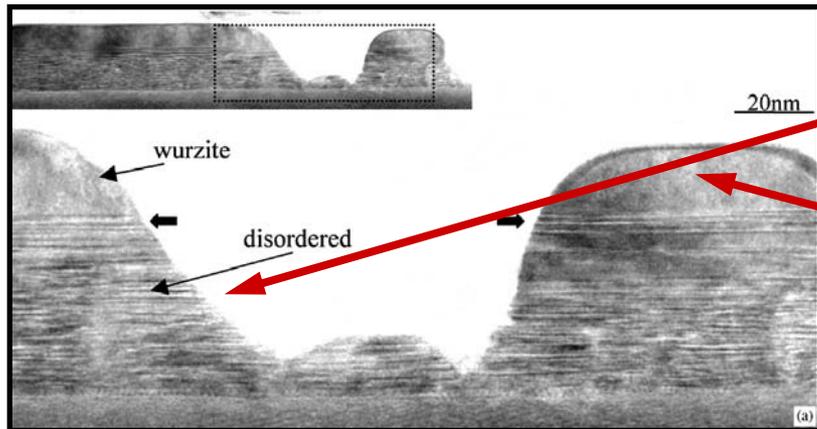
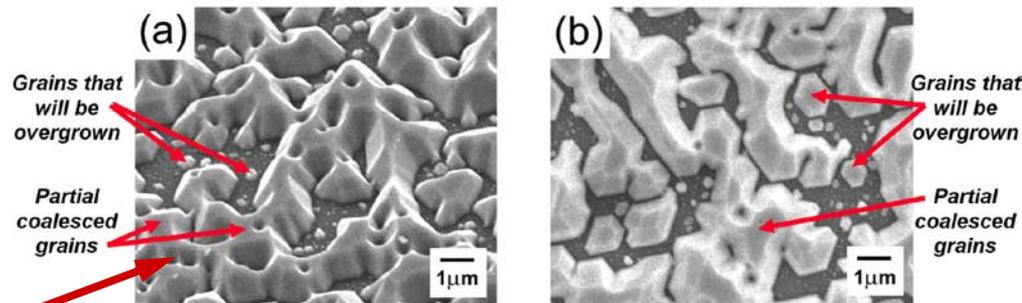


Figure from Lada et al., J. Crystal Growth 258, 89 (2003).

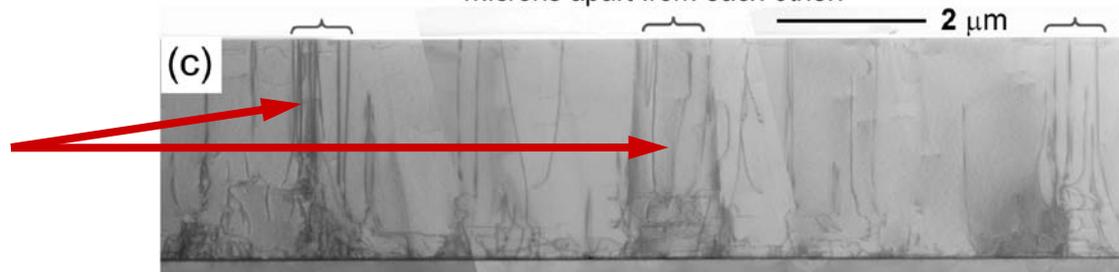
- As grown GaN nucleation layers contain disordered GaN with many stacking faults.
- Once annealed, wurtzite GaN forms on top of disordered GaN NL, forming nano-sized GaN nuclei from which further high temperature GaN growth occurs.

- High temperature growth on the GaN nuclei produces GaN grains.
- Growth conditions can be varied to enhance the pyramidal growth mode or lateral coalescence. Dislocations are bent laterally on pyramidal facets.
- Dislocations are concentrated in bunches located microns apart.

SEM Images of 3D GaN grain growth



The threading dislocation appear in bunches which are located a few microns apart from each other.

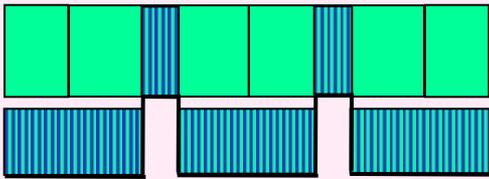


TEM cross section

# Methods for growing bulk GaN

## Dislocation Filtering Techniques

### Lateral Overgrowth



### HVPE



Liftoff process

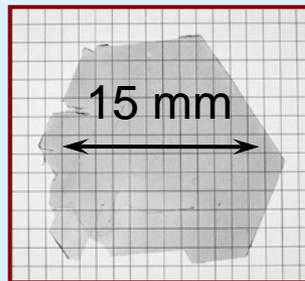
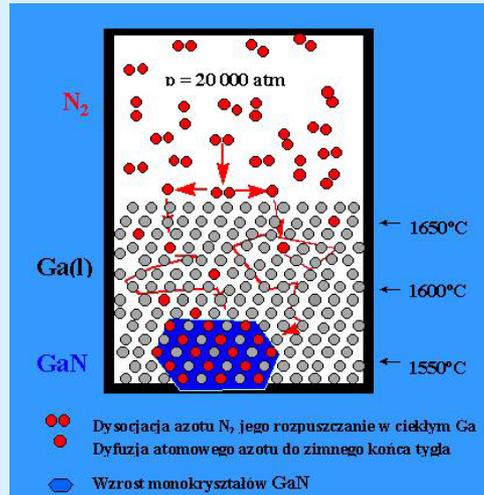


Polishing



## "True" Bulk Techniques

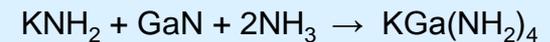
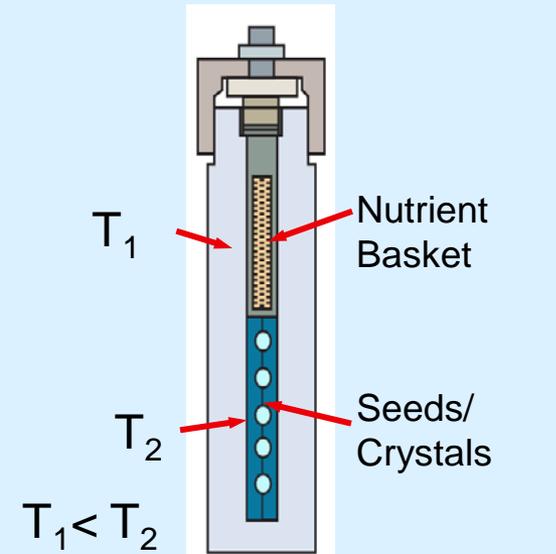
### High Nitrogen Pressure



$P = 10^5\text{ atm}$   
 $T = 1500\text{ C}$   
 $t = 100\text{ hr}$   
 $h = 100\text{ }\mu\text{m}$

Dislocation density =  $10^2\text{ cm}^{-2}$

### Ammonothermal growth



4,000 – 5,000 atm

$T = 400 - 800^\circ C$

G.R. = 50  $\mu\text{m/day}$

Multiple seeds



# Desires/Requirements for a Bulk Growth Technique

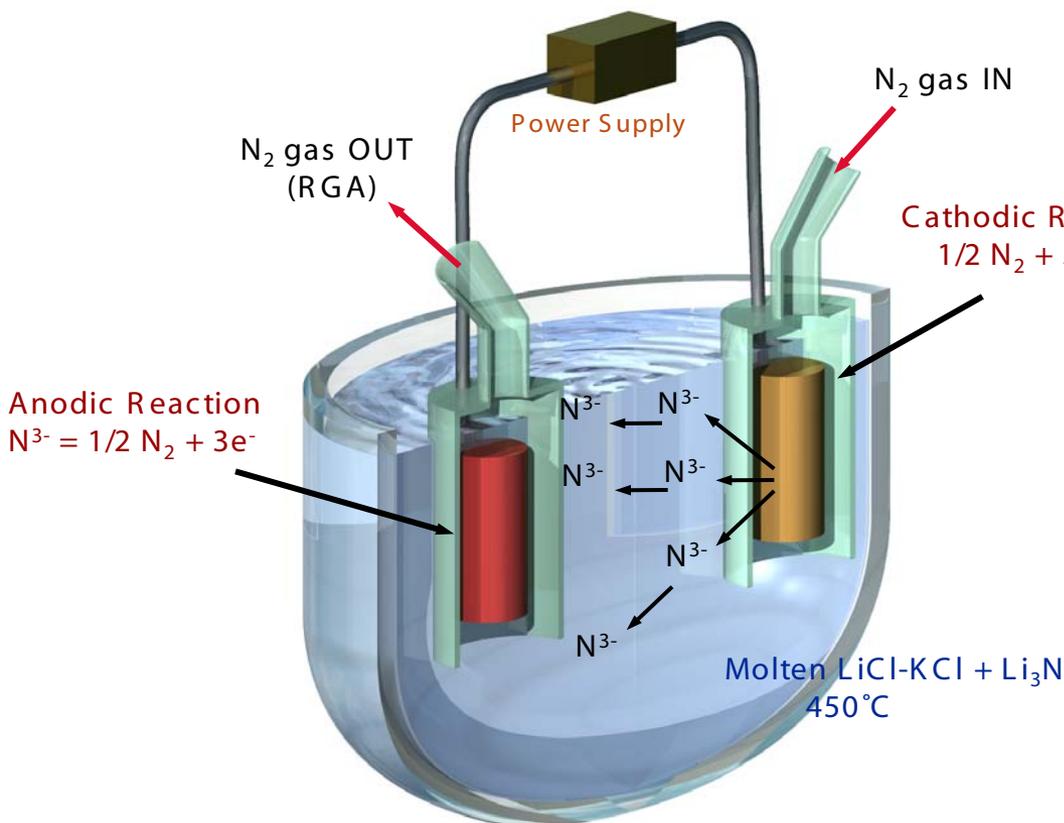
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- **Good crystalline quality ( $\rho \leq 1 \times 10^5 \text{cm}^{-2}$ )**
- **High growth rate ( $\sim \text{mm/hr}$ ): high throughput, high volume production**
- **Low impurity content**
- **Scalable**
- **Controllable**
- **Manufacturable**
- **Reasonably inexpensive**
- **Applicable to InN, GaN, AlN, and III-N alloys**

# $1/2\text{N}_2 + 3\text{e}^- \rightarrow \text{N}^{3-}$ : The Reactive Intermediate

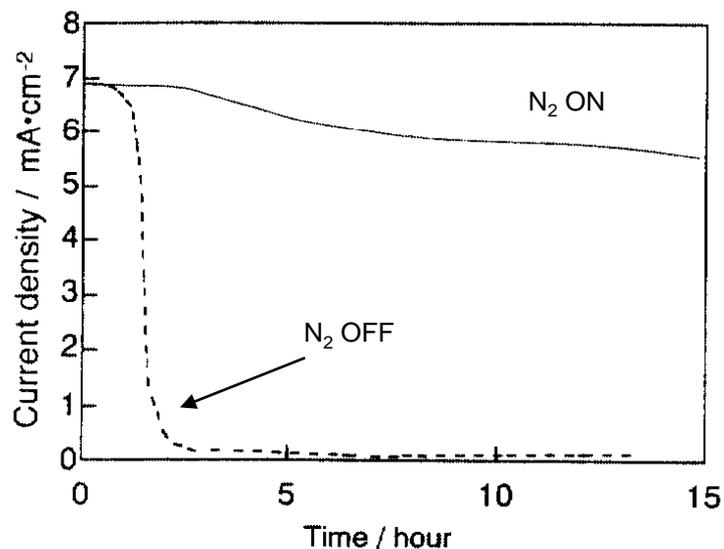
- T. Goto and Y. Ito, "Electrochemical reduction of nitrogen in a molten chloride salt" *Electrochimica Acta*, Vol. 43, Nos 21-22, pp 3379-3384 (1998).

Found that nitrogen was **continuously** and **nearly quantitatively** reduced to nitride ions



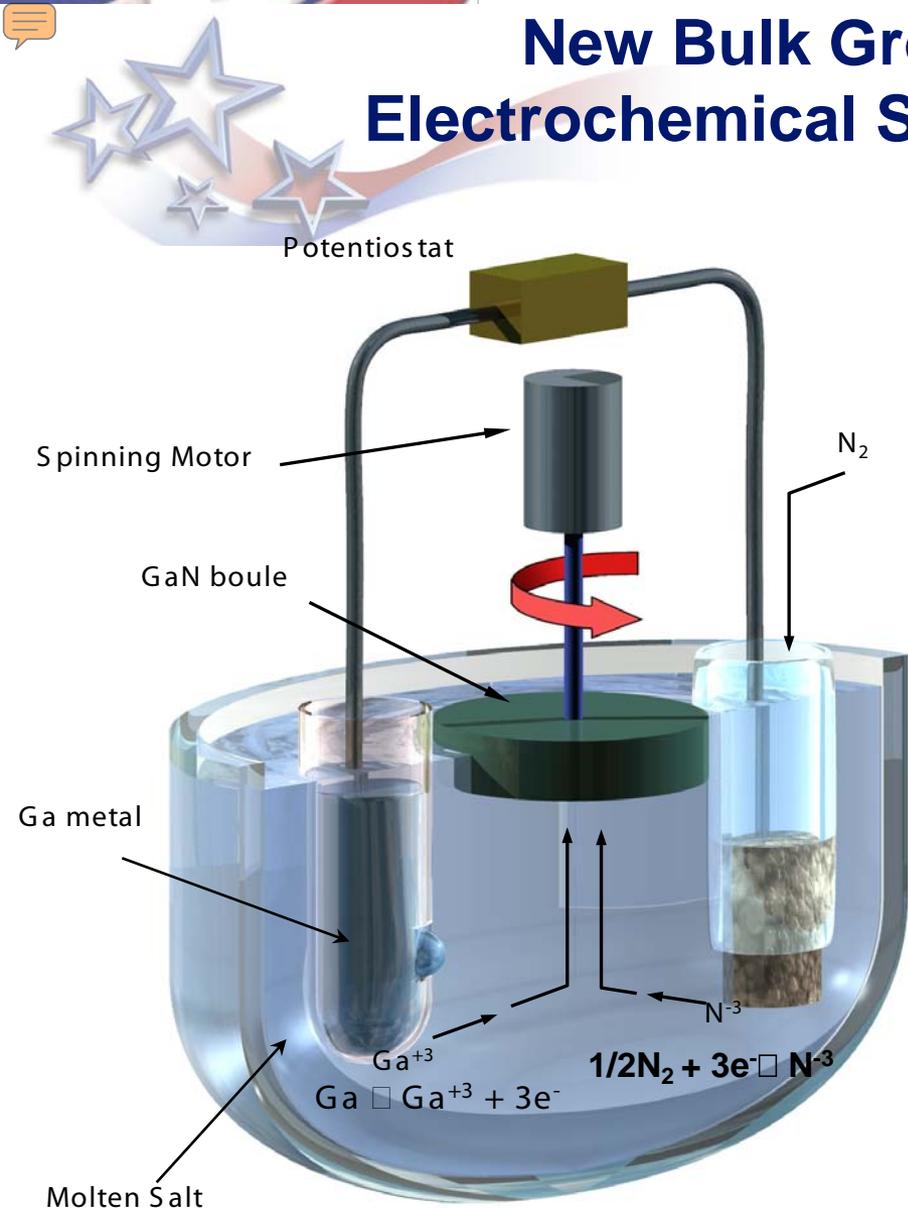
Advantages of using N<sub>2</sub> gas:

- Clean
- Inexpensive
- Control over precursor conc.
- Continuous, controlled supply



Report of nitride concentration in LiCl in literature: 12 mole %

# New Bulk Growth Technique: Electrochemical Solution Growth (ESG)



Note that this is not electrodeposition!

- Avoids requirement for conductive materials
- Avoids purity, crystalline quality issues

Uses rotation of seed/boule to deliver ionic precursors (changes growth physics!)

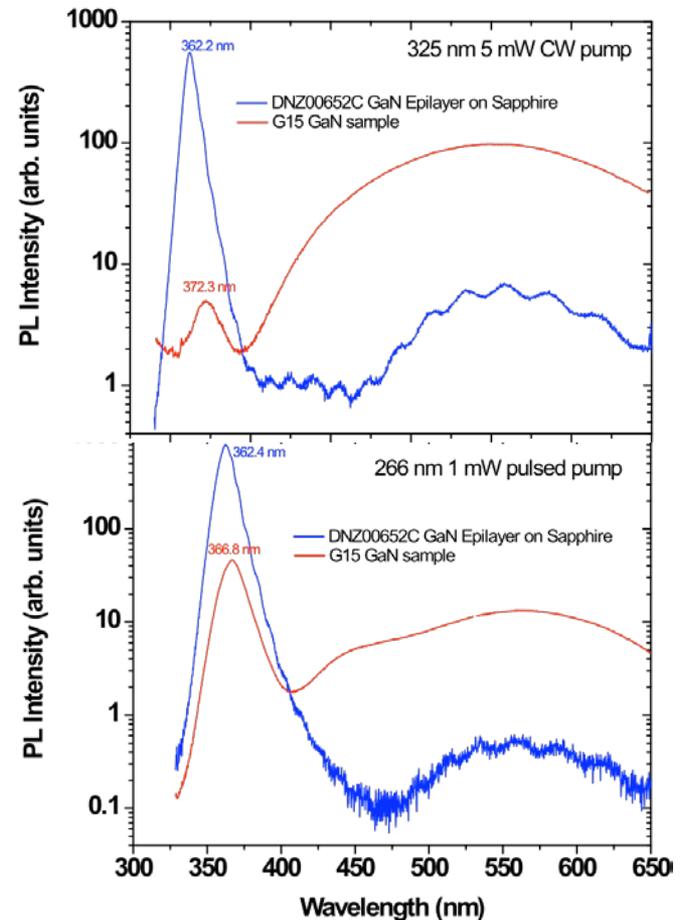
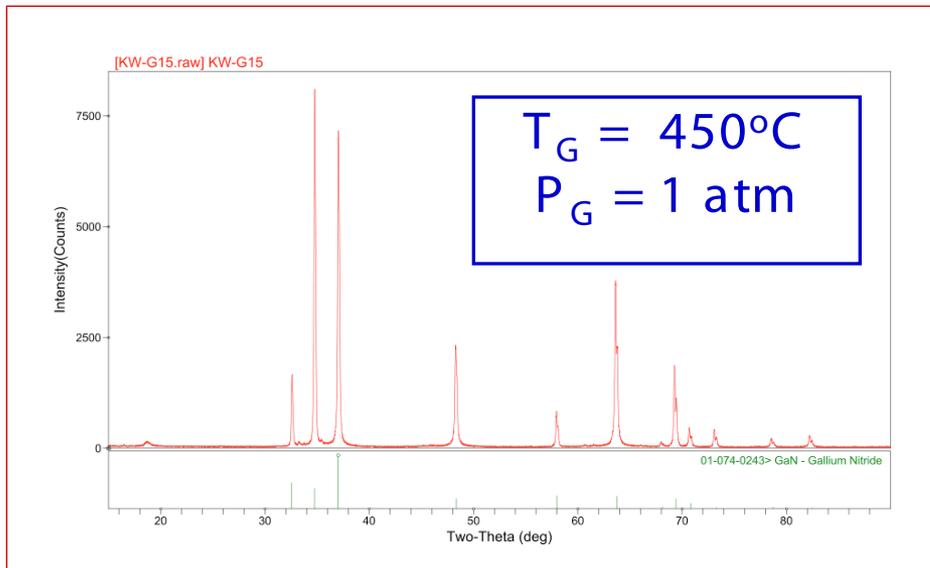
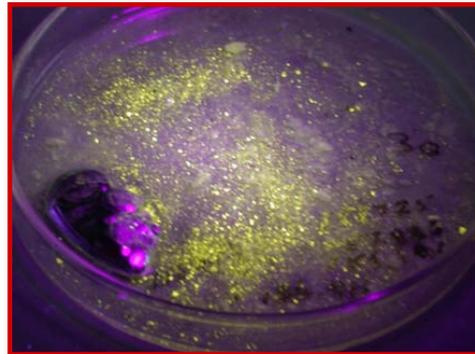
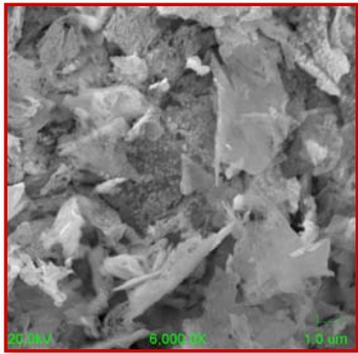
Highlights of Advantages:

- **Highest quality crystals** produced by solution growth (disl. densities  $\sim 10^2 \text{ cm}^{-2}$ )
- **Manufacturable process** because electrochemistry controls concentrations
- **Fully Scalable** because seed/boule rotation produces uniform lateral Temp/Concentration and T, C gradients
- **Inexpensive** because relatively high concentrations enable mm/hr growth rates

Path Forward:

- Demonstrate seeded growth (*in situ* seed prep)
- Tune growth parameters to produce high quality boules
- Transfer process to commercial 6" reactor (available for use)

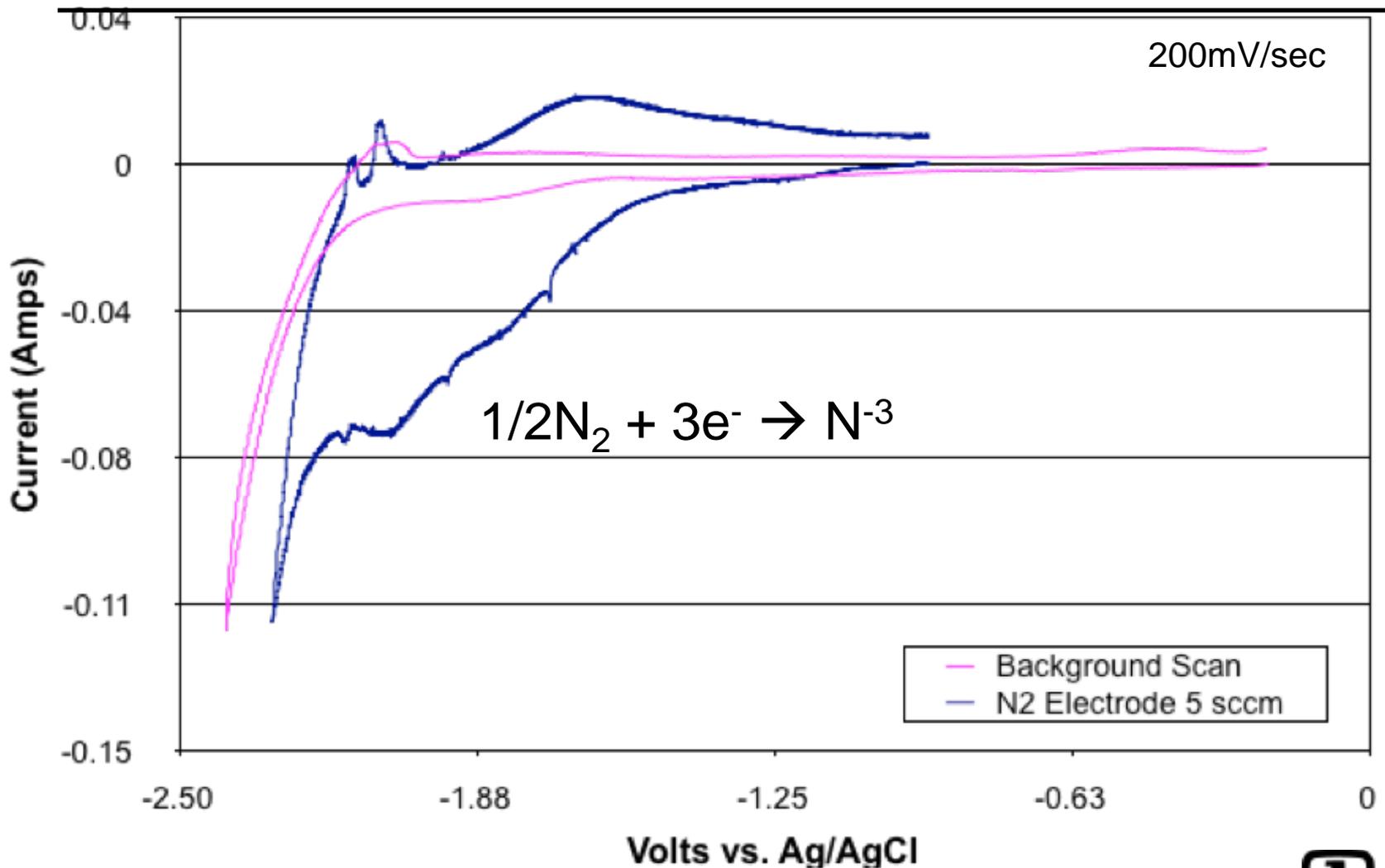
# GaN ESG Produces Photoluminescent GaN Crystallites



Mary Crawford, SNL



# Example of Nitrogen Gas Reduction Cyclic Voltammograms

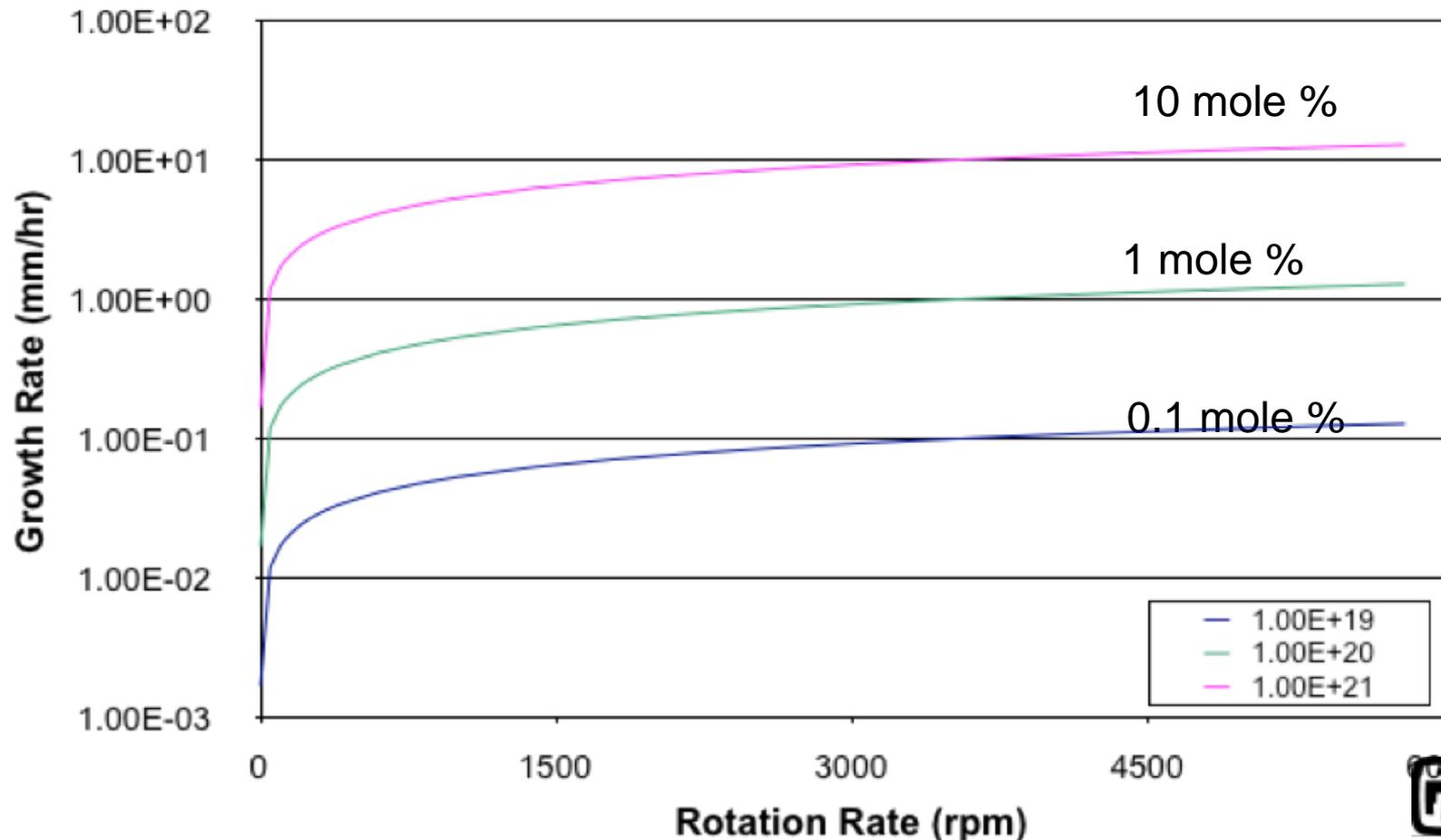


# Industrial Partner (GNOEM) Hardware Development



# Growth Rate vs. Rotation Speed and Concentration

$$GR \text{ (mm/hr)} = \frac{a^2 c (3)^{1/2} * 0.62 D_o^{2/3} \lceil 1/2 v^{-1/6} C_o *}{4} \times \frac{10 \text{mm} * 3600 \text{s}}{\text{cm} * \text{hr}}$$





# Summary: Path For Development

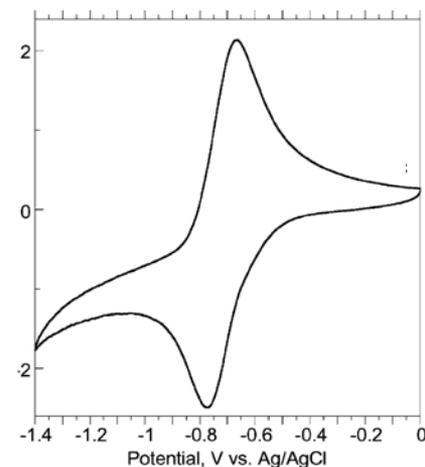
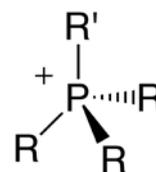
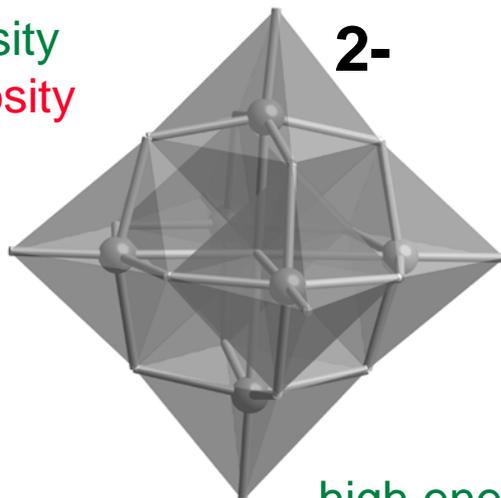
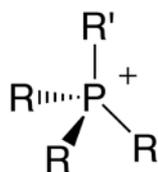
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- ✓ • **Demonstrate that chemistry is viable**
  - Kinetics and thermodynamics are favorable in this setup
- ✓ • **Check for dissolution and precipitation approach**
- ✓ • **Develop N<sub>2</sub> electrochemical reduction methods**
- ✓ • **Develop initial fluid dynamics schemes**
- ⇒ • **Deposit GaN on a seed crystal**
  - **Improve crystal quality**
  - **Optimize growth rate**

# Electroactive Ionic Liquids

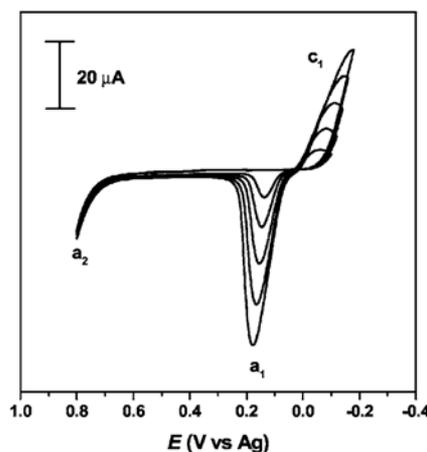
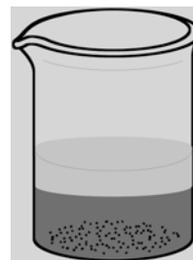
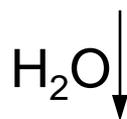
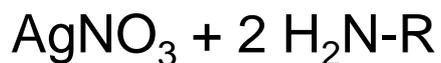
high energy density  
detrimental viscosity

ANL  
Work



high energy density  
low yield  
expensive synthesis

ORNL  
Work





# Magnetic Susceptibility Studies

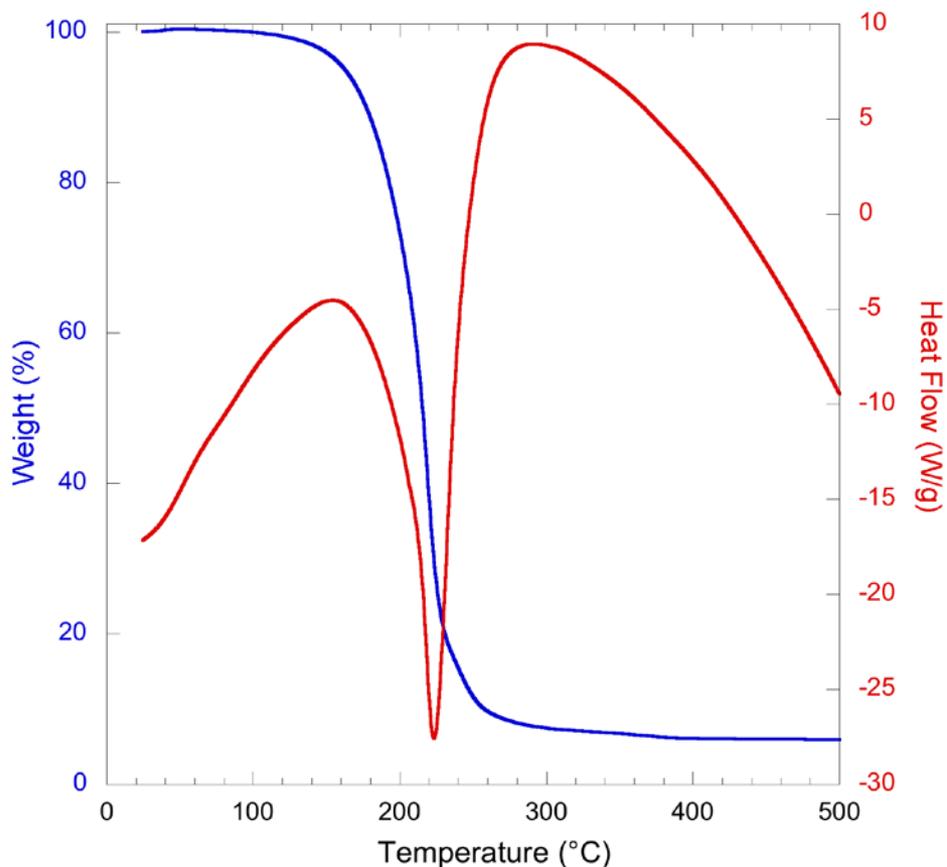
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<u>Compound</u>	<u>Calculated <math>\chi</math></u>	<u>Measured <math>\chi</math> (<math>\pm 0.05</math>)</u>
$\text{Cb}_2\text{Cu}(\text{EA})_6$	1.73 BM	1.50 BM
$\text{Cb}_2\text{Cu}(\text{dEA})_6$	1.73 BM	1.69 BM
$\text{Cb}_2\text{Cu}(\text{tEA})_6$	1.73 BM	1.72 BM
$\text{Tf}_2\text{Cu}(\text{dEA})_6$	1.73 BM	1.60 BM
$\text{Tf}_2\text{Zn}(\text{EA})_6$	0	0
$\text{Tf}_2\text{Zn}(\text{EA})_4$	0	0
$\text{Tf}_3\text{Fe}(\text{dEA})_6$	5.90 BM	5.87 BM

diamagnetic

-smaller ligands and anions promote  
**antiferromagnetic coupling**

# Thermal Stability Studies

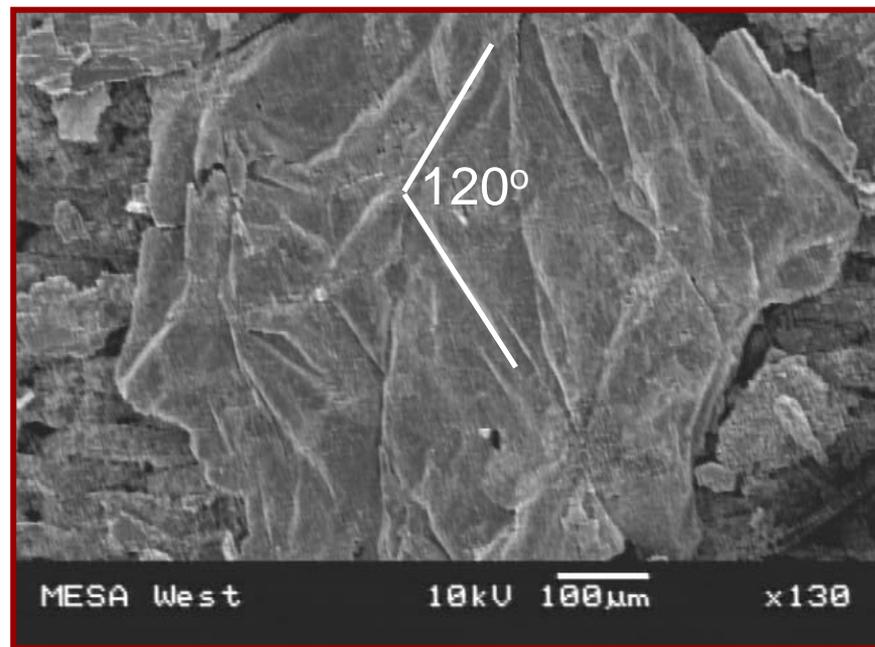
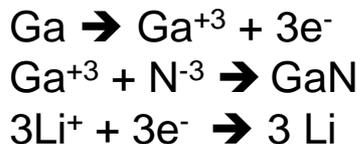
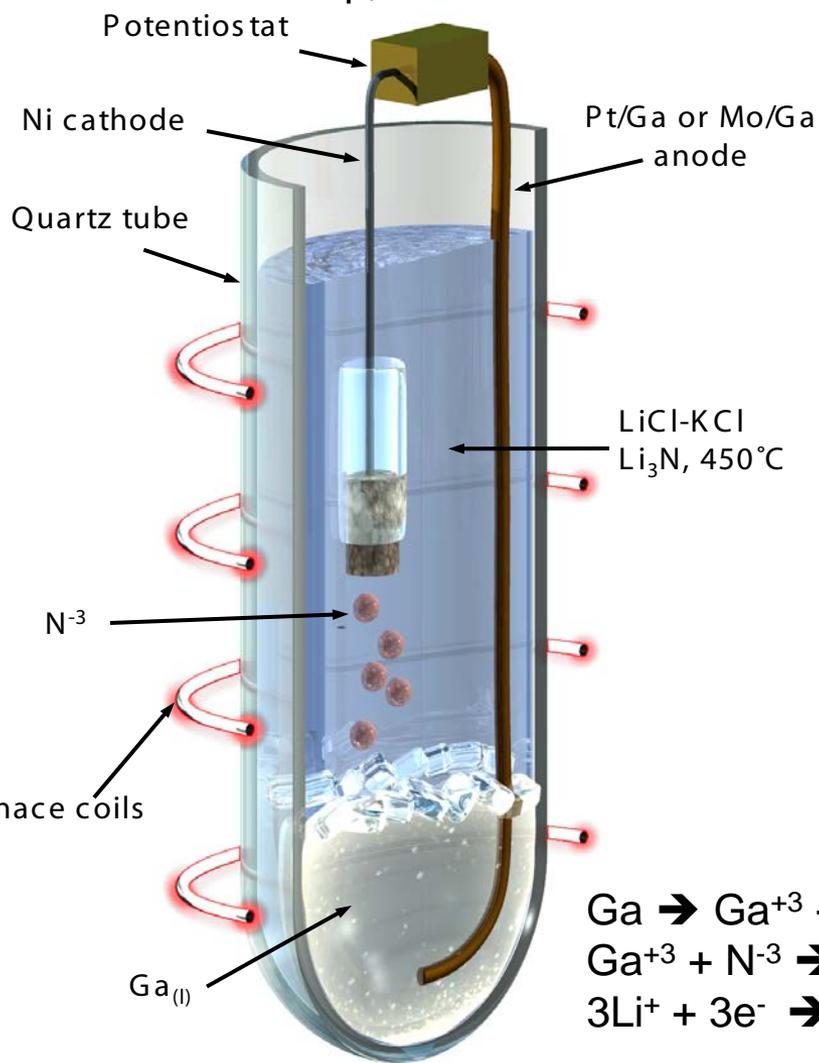


tunable based on metal,  
ligand, and anion

Complex	Disassociation Temperature
$\text{Tf}_2\text{Zn}(\text{EA})_4$	150 °C
$\text{Tf}_2\text{Zn}(\text{EA})_6$	150 °C
$\text{Cb}_2\text{Cu}(\text{EA})_6$	185 °C
$\text{Tf}_2\text{Cu}(\text{dEA})_6$	210 °C
$\text{Cb}_2\text{Cu}(\text{dEA})_6$	225 °C
$\text{Cb}_2\text{Cu}(\text{tEA})_6$	250 °C
$\text{Tf}_3\text{Fe}(\text{dEA})_6$	255 °C

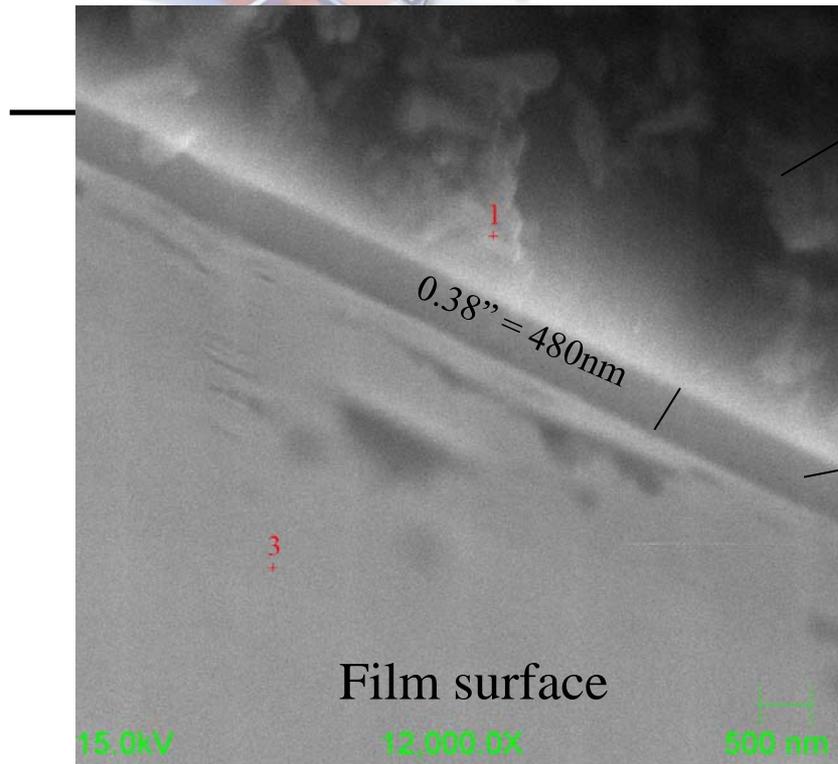
# Initial Experimental Setup: Unseeded Growth of GaN in a Test Tube

$\text{Li}_3\text{N}$  or  $(\text{Li}_3\text{N} + \text{N}_2) + \text{Ga}$ ,  $450^\circ\text{C}$ , current sweep, 2 hours

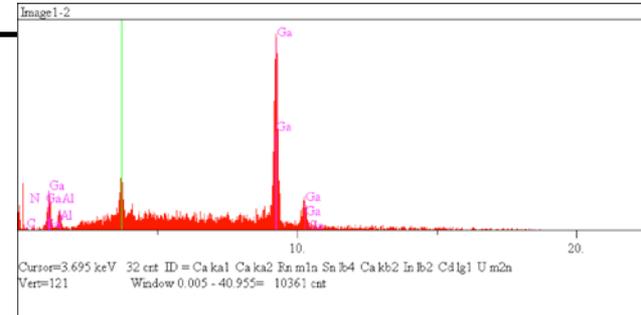


Produced numerous wurtzite GaN crystals;  
This crystal was ~1.25mm long x 0.8mm wide

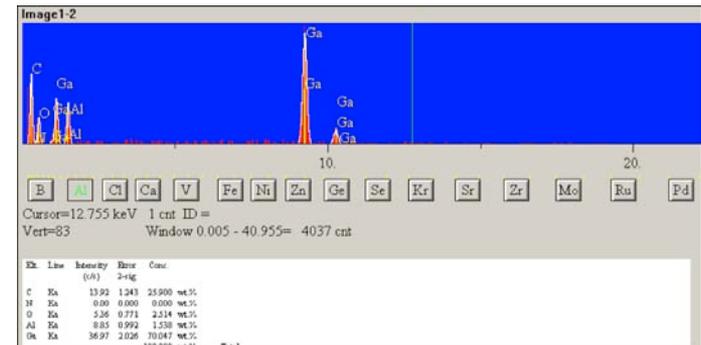
# SEM of RD-ESG Growth Run #1



MOCVD-grown GaN

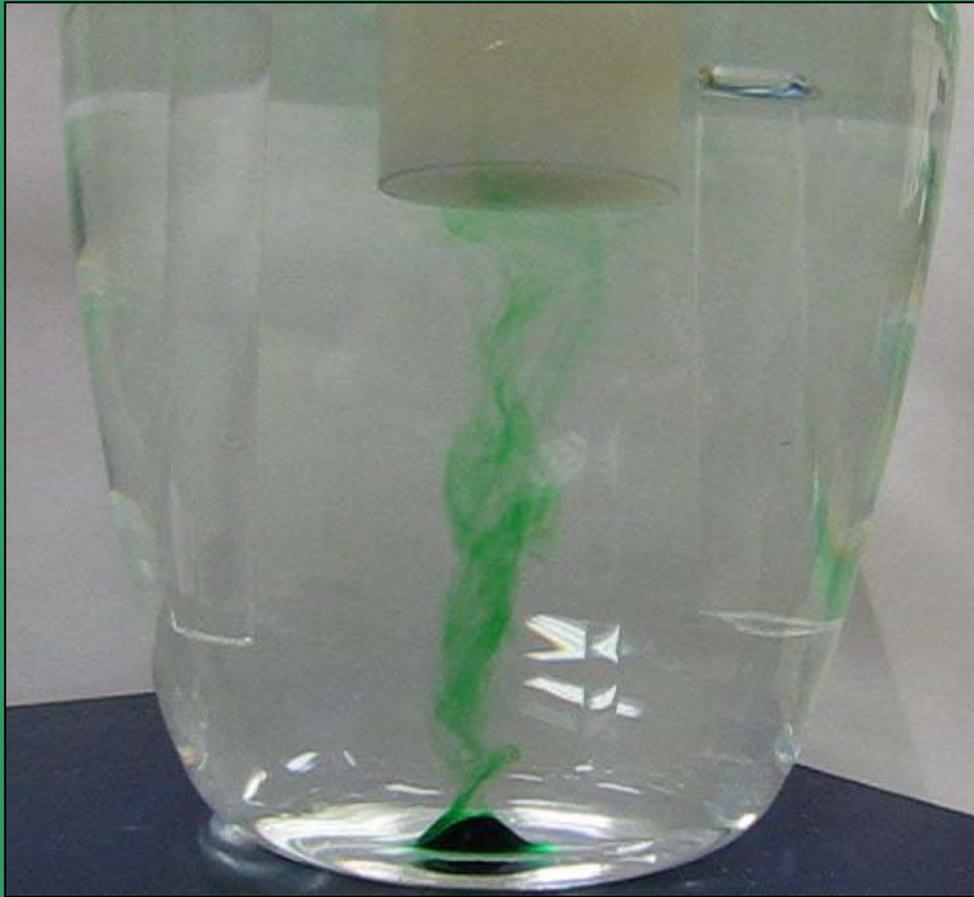


Ga, Al-containing layer



- SIMS revealed the layer to be a graphitic carbon layer, with Ga, N, and GaN clusters
  - GaN content was about 10%
  - Profile was consistent with an increasing concentration
- Problem with salt purity from supplier
  - Working it out with supplier
  - Developing in-house purification technique for reagent grade salt

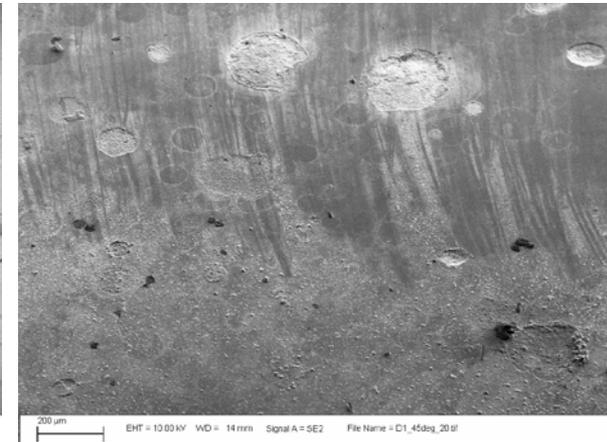
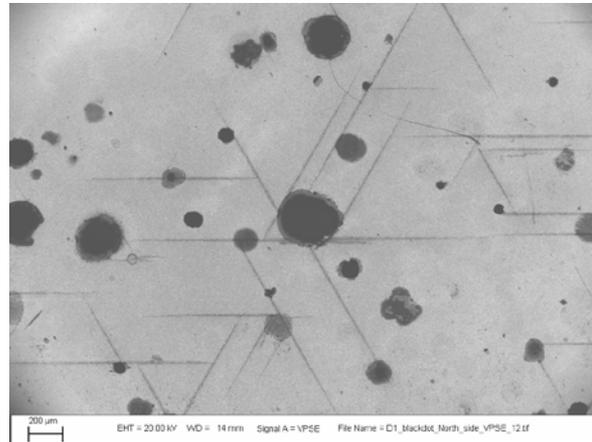
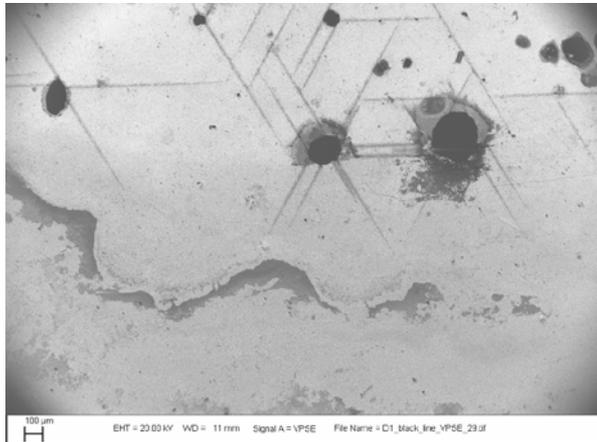
# Room Temperature Convection Experiments



Under laminar flow conditions, the spinning seed will draw nutrient-containing fluid to the surface– if the electrodes are properly shaped and located.



# First GNOEM RD-ESG Experiment



- **Hardware failure—** susceptor sheared, not sure when
- **Black line on sample surface delineated a higher, specular region and lower, roughened area**
- **Defect selective etching observed (several microns/hr)**
- **Highly encouraging for crystal quality**
  - **Must identify the conditions under which this takes place**
- **Polished cross sections of control and experiment sample consistently measure about 1 μm thicker for experiment**

